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U.S.S.N. 10/791,607

APR 1 5 2009

In the Claims

Please cancel Claims 29,30 and 41 without prejudice. Please amend Člaims 28,31 and 33 as follows:

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Listing of Claims

Claims 1-25 (canceled)

- 26. (previously presented) A phase change memory structure comprising:
 - a substrate comprising a conductive area;
- a spacer comprising a phase changing material sensitive to temperature and having a partially exposed sidewall region at the spacer upper portion defining a contact area, said contact area comprising an upward sloping positive radius of curvature; and

an upper conductive electrode on said contact area;
wherein a spacer bottom portion partially overlaps the
conductive area and said upper conductive electrode at least
partially overlaps said contact area.

- 27. (original) The phase change memory structure of claim 26, wherein the upper conductive electrode comprises a material selected from the group consisting of W, TiN, TiW, TiAl, TiAlN, and combinations thereof.
- 28. (currently amended) A phase change memory structure comprising:
 - a substrate comprising a conductive area;

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a spacer having a partially exposed sidewall region at the spacer upper portion defining a contact area, said contact area comprising an upward sloping positive radius of curvature; ,an upper conductive electrode at least partially overlaps said contact area;

wherein the spacer comprises a material selected from the group consisting of a conductive material and a phase changing material sensitive to temperature; said spacer further comprises a memory element, and,

wherein a spacer bottom portion at least partially overlaps the conductive area.

Claims 29-30 (canceled)

- 31. (currently amended) The phase change memory structure of claim $\frac{30}{28}$, wherein the phase changing material comprises a chalcogenide.
- 32. (original) The phase change memory structure of claim 31, wherein the chalcogenide comprises a material selected from the group consisting of Ge, Te, and Sb and their alloy system.
- 33. (currently amended) The phase change memory structure of claim $\frac{30}{28}$, wherein the upper conductive electrode comprises a

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material selected from the group consisting of W, TiN, TiW, TiAl, TiAlN, and combinations thereof.

Claims 34-41 (canceled)